

Rec'd PCT/PTO 25 FEB 2005



מדינת ישראל
STATE OF ISRAEL

PCT/IL 03 / 00373

REC'D 30 JUN 2003

WIPO PCT

10/525568

Ministry of Justice
Patent Office

משרד המשפטים
לשכת הפטנטים

This is to certify that
annexed hereto is a true
copy of the documents as
originally deposited with
the patent application
of which particulars are
specified on the first page
of the annex.

זאת לתעודה כי
רצופים בזה העתקים
נכונים של המסמכים
שהופקדו לכתחילה
עם הבקשה לפטנט
לפי הפרטים הרשומים
בעמוד הראשון של
הנספח.

PRIORITY DOCUMENT

SUBMITTED OR TRANSMITTED IN
COMPLIANCE WITH RULE 17.1(a) OR (b)

This 14-05-2003 היום

רשם הפטנטים

רשם הפטנטים

Commissioner of Patents

BEST AVAILABLE COPY

נתאשר
Certified

לשימוש הלשכה
For Office Use

חוק הפטנטים, תשכ"ז -
PATENTS LAW, 5727-1967

בקשה לפטנט
Application For Patent

מספר: Number	149557
תאריך: Date	9-05-2002
הוקדם/נדחה: Ante/Post-dated	

אני, (שם המבקש, מענו ולגבי גוף מאגדת מקום התאגדותו)
I, (Name and address of applicant, and in case of body corporate-place of incorporation)

נובה מכשירי מדידה בע"מ, חברה ישראלית מוייצמן פארק למדע, ת"ד 266, רחובות 76100, ישראל
Nova Measuring Instruments Ltd., Israeli Company of Weizmann Scientific Park, P.O.B. 266, Rehovot 76100, ISRAEL

ששמה הוא Right of Law
of an invention the title of which is

בעל אמצאה מכח
Owner, by virtue of

מערכת אופטית הפועלת עם זווית פגיעה משתנה

(בעברית)
(Hebrew)

An optical system operating with variable angle of incidence

(באנגלית)
(English)

Hereby apply for a patent to be granted to me in respect thereof.

מבקש בזאת כי ינתן לי עליה פטנט

• בקשת חלוקה Application of Division	• בקשת פטנט מוסף Appl. for Patent of Addition	דרישת דין קדימה Priority Claim		
מבקשת פטנט from application	• לבקשה/לפטנט to Patent/Appl.	מספר/סימן Number/Mark	תאריך Date	מדינת האירגון Convention Country
No. _____	No. _____			
Dated _____	Dated _____			
P.O.A.: _____				
• יפוי כח: _____				
המען למסירת מסמכים בישראל Address for Service in Israel				
C. 138220				
REINHOLD COHN AND PARTNERS Patent Attorneys P.O.B. 4060, Tel-Aviv				
ריינהולד כהן ושותפיו עורכי פטנטים ת"ד 4060, תל-אביב				
חתימת המבקש Signature of Applicant בשם המבקשים, ריינהולד כהן ושותפיו ע"י: _____				
		שנת 2002 בחודש May 9 היום This		
		לשימוש הלשכה For Office Use		

טופס זה כשהוא מוטבע בחותם לשכת הפטנטים ומושלם במספר ובתאריך ההגשה, הנו אישור להגשת הבקשה שפרטיה רשומים לעיל.
This form, impressed with the Seal of the Patent Office and indicating the number and date of filing, certifies the filing of the application the particulars of which are set out above.

• מחק את המיותר
Delete whatever is inapplicable

מערכת אופטית הפועלת עם זווית פגיעה משתנה

An optical system operating with variable angle of incidence

Nova Measuring Instruments Ltd.

נובה מכשירי מדידה בע"מ

C. 138220

AN OPTICAL SYSTEM OPERATING WITH VARIABLE ANGLE OF INCIDENCE

FIELD OF THE INVENTION

The present invention is generally in the field of optical monitoring/inspection techniques, and relates to a spectrometer method and system.

BACKGROUND OF THE INVENTION

Spectrometer-based techniques, such as spectrophotometry and spectral ellipsometry, are widely used in microelectronics for measuring thin film properties and line profiles. An object to be measured may be a site on a semiconductor wafer (multi-layer stack) that may have with uniform thin-film structure, or may be patterned, e.g., line array in at least one layer of the multi-layer stack. If wavelength of incident light is of the order of the line array period, reflected light is zero-order diffracted light, while higher orders are scattered in different directions and do not reach an optical detector oriented to be capable of detecting the reflected light (scatterometry). For both the specular reflection and zero-order diffraction, the light used for measurements may be polarized. Measurement schemes may be of the kind based on measuring intensity of light (spectrophotometry) or polarization changes (ellipsometry).

An object under measurements, either of uniform or patterned structure may thus be described by an optical model with a set of parameters, such as optical constants, thickness of each layer, pattern geometry and profile. Measurement of a single spectrum is usually incapable of determining more than

two-three unknown parameters of this set with high accuracy and high level of confidence. Hence, if more parameters of the optical model of a measured structure are unknown and are to be simultaneously determined from spectral measurements, more such measurements are to be independently carried out. The known approaches to increase the number of independent measurements (applicable for both the spectrophotometry and ellipsometry) are generally based on the following:

1. Step-by-step removal and measurements of the same stack downward to the substrate layer. Although this approach enables as many independent measurements as needed, it is destructive and is hard to implement for measuring wafers in production.

2. Step-by-step deposition and measurements of the stack layers. This approach provides a required number of measurements, but is timely consuming.

3. Individual deposition of each or some critical layers on a substrate and separate measurements of each of these layers. By this, measurements in a simple single-layer structure allows for determining both the optical properties and thickness of the single layer. The single-layer measured parameters can then be excluded from unknown parameters of the whole stack. This technique is also time consuming, requires a large number of test wafers, and does not take into consideration the fact that the optical properties of a specific layer may be different when the layer is a part of a multi-layer stack, and therefore does not provide confident information.

4. Applying measurements to the same wafer in different ambiances, e.g., in air and in water, etc. This technique provides more information about the wafer, but a different ambience might cause some chemical changes of the wafer's top layer, such as photoresist.

5. Measurements of the same site on a wafer with different angles of light incidence. Fig. 1 schematically illustrates such a variable angle measurement

system 10, for example the H-VASE model commercially available from J.A. Woolam Co., Inc. The system has two arms 12 and 14 mounted for pivotal movement about a pivot axis 16 along a curved frame 18. The arms 12 and 14 are L-shaped and carry a light source 20 and a detector 22, respectively. In order to cover the entire surface of a wafer W, the latter is supported on a movable X-Y stage 24, which preferably is also Z-adjustable. This approach provides more information than the single incident angle technique, but suffers from the following drawbacks:

- long measurement time, which while being acceptable for material characterization, is not acceptable for production;
- a measurement system of a large footprint and size, which does not comply with the requirements for a measurement system in production, e.g., integrated metrology system;
- requirement for a massive and rigid mechanical platform, in order to provide accurate changing of the angle of incidence that can hardly be used for integrated metrology.

SUMMARY OF THE INVENTION

There is accordingly a need in the art to facilitate optical measurements in a sample, especially a multi-layer structure, by providing a novel method and system operable with variable angles of illumination and light collection.

The present invention provides for varying the angle of incidence of light onto a specific location (site) on the sample and, optionally also for varying the angle of collection of light returned from this site. The system according to the invention requires neither movement of a light source nor of a light detector, but rather utilizes a light directing assembly having a plurality of deflector elements defining a plurality of incident angles. Interaction of an incident beam with a selected one of the deflector elements provides a selected angle of incidence of

the beam onto the sample. Preferably, the plurality of deflector elements has deflector elements located in a detection channel as well, thereby enabling interaction of the returned beam with a selected deflector element and accordingly a selected angle of light collection by a detector unit.

There is thus provided according to one aspect of the present invention, an optical system for use in measurements in a sample, the system comprising:

- (a) a light source operable to produce an incident light beam propagating in a certain direction towards the sample through an illumination channel;
- (b) a detector unit for collecting light coming from the sample through a detection channel, and generating data indicative of the collected light;
- (c) a light directing assembly operable to direct the incident beam onto a certain location on the sample's plane with a plurality of incident angles, and to direct light returned from the illuminated location to the detector unit, the light directing assembly comprising a plurality of beam deflector elements, at least one of the deflector elements being movable, a position of said at least one movable deflector element defining a selected one of the incident angles.

According to one embodiment of the invention, the plurality of the deflector elements has two arrays of the deflector elements, one array being located in the illumination channel and the other array being located in the detection channel. Each of the arrays may be formed by deflector elements arranged in a spaced-apart relationship along the respective channel, in which case the deflector elements may be planar mirrors with or without associated focusing lenses, at least one of the deflector elements being movable. Each of the arrays may be formed by a reflecting surface of a parabolic-sector mirror, in which case the light directing assembly preferably comprises at least one movable planar mirror in the illumination channel, and preferably also comprises a movable planar mirror in the detection channel. According to another

embodiment of the invention, the plurality of deflector elements comprises a single parabolic-sector mirror that faces the sample's plane with its reflecting surface. In this case, the light directing assembly comprises planar mirrors, at least one being movable between a plurality of operative positions thereby defining the plurality of the incident angles.

According to another aspect of the present invention, there is provided, a method for measuring in a sample, the method comprising:

- (i) providing an incident light beam propagating in a certain direction towards the sample along an illumination channel;
- (ii) directing the incident beam onto a certain location on the sample's plane with a plurality of incident angles, said directing comprising deflecting the incident beam by a selected one of a plurality of deflector elements resulting in the selected one of the angles of incidence of the beam onto said certain location.

BRIEF DESCRIPTION OF THE DRAWINGS

In order to understand the invention and to see how it may be carried out in practice, a preferred embodiment will now be described, by way of non-limiting example only, with reference to the accompanying drawings, in which:

Fig. 1 is a schematic illustration of the prior art multi-angle optical system;

Fig. 2 is a schematic illustration of an optical system according to one embodiment of the invention;

Figs. 3A to 3D more specifically illustrate three possible examples, respectively, of a deflection element suitable to be used in the optical system of Fig. 2;

Fig. 4 schematically illustrates an optical system according to another embodiment of the invention;

Fig. 5 is a schematic illustration of an optical system according to yet another embodiment of the invention, utilizing the multi-angle illumination/detection and also normal-incidence illumination/detection and/or imaging;

Figs. 6A and 6B illustrate two more examples of using normal-incidence illumination/detection or imaging channel in the optical system of the invention;

Figs. 7A and 7B illustrate optical systems according to yet another examples of the invention designed for carrying out multi-angle and normal incidence measurement/monitoring, as well as imaging and auto-focusing functions;

Fig. 8 is a schematic illustration of yet another embodiment of the invention, wherein a deflector assembly comprises a parabolic-sector mirror; and

Fig. 9 illustrates how the system of the present invention can be used for measuring diffraction efficiency for the first (negative) diffraction order additionally to zero order standard measurements.

DETAILED DESCRIPTION OF THE INVENTION

Fig. 1 shows the prior art optical system capable of providing various angles of incidence of a light beam onto a sample.

Referring to Fig. 2, there is illustrated an optical system 100 according to one embodiment of the invention applied to a sample (e.g., wafer) S. The system 100 comprises such main constructional parts as a light source 102 (e.g., a Xe lamp) producing an incident light beam B, which in the present example propagates from the light source parallel to an axis OA normal to the sample's plane; a detector unit 104 (e.g., spectrophotometer); and a light directing assembly, generally at 106, comprising a plurality of deflector elements. Light beam B propagates through an illumination channel IC, impinges onto the sample at a location L, and returned light B' (reflected and/or scattered)

propagates through a detection channel DC towards the detector 104. The sample is typically supported on a stage, and in order to measure/monitor a plurality of sample's sites a relative displacement between the sample and the optical system (at least deflector assembly) is provided, preferably by moving the stage with respect to the optical system. The stage may be of different types, i.e., x,y- or r, θ -movable stage for scanning the entire surface of the wafer, and z-movable for bringing the measurement site to the best focus of the optical system.

In the present example of Fig. 2, the plurality of deflector elements in the light directing assembly 106 has two arrays of deflector elements 108 and 110 located at both sides of the axis OA. The array 108 is associated with the light source 102 (illumination channel IC) and the array 110 is associated with the detector unit 104 (detection channel DC). Additionally, in the present example of Fig. 2, each of the arrays 108 and 110 has separate (discrete) deflector elements -- four such elements 108A-108D and 110A-110D in the arrays 108 and 110, respectively, which are arranged in a spaced-apart relationship within the respective channel. All the deflector elements, except for the lowermost ones (closest to the sample's plane) 108D and 110D, are movable to be in and out of the optical path of the respective beam (incident or returned), e.g., are mounted for a reciprocating movement along X- or Y-axis. Generally speaking, each beam deflector element in the array can be in its operative state, in which it is in the path of the respective light beam, and can be in its inoperative state, in which it is out of the path of the respective beam. This can be implemented in different ways, namely, by reciprocating, rotating or pivotal movement of the element with respect to the path of the light beam propagation towards the element. When the selected one of the deflector elements is in the optical path of the light beam, all other elements are out of this path. For example, the deflector elements can be sequentially shifted between the two positions. This can be realized by locating the uppermost deflector element 108A in the path of the emitted beam B, thereby

automatically preventing the beam interaction with the other elements 108B-108D, and providing the beam incidence onto the location L on the sample with a certain incident angle θ_1 . In this case, the deflector elements 110A-110D of the detection channel are arranged such that the deflector element 110A only is in the path of the specularly reflected beam B'. Then, the uppermost element 108A is shifted away from the axis OA, thereby automatically providing the incident beam deflection by the next element 108B, etc. It should be understood that in order to provide the operative state of a selected deflector element, not necessarily this selected element is to be moved, but rather one or more other elements of the deflector assembly, as will be exemplified further below.

As shown in Fig. 2, the incident beam interaction with a different one of the deflector elements 108A-108D results in a different angle of incidence of the beam B onto the same location (point) L on the sample. To this end, the deflector elements are differently oriented with respect to the axis OA. In the example of Fig. 2, variation of the angle of light collection (detection) is aimed at collecting only specular reflections of the incident beam. It should also be noted that the movable elements of the illumination and detection channels forming a pair with respect to the certain incident/collected angle, e.g., elements 108A and 110A, can be associated with a common drive.

The number of different angles of incidence/collection depends on the opto-mechanical design of the system 100. Practically, the provision of four-five angles is sufficient for most of the inspection/monitoring applications, enabling the system (including both the illumination and the detection channels) to be compact, up to the wafer size (200-300mm).

Since each deflector element in the arrays of the illumination and detection channels can be separately aligned, a very high accuracy of alignment can be achieved, which enables to provide accurate location of the illumination spot (location L) on the chosen measurement site. During the alignment

procedure, a nominal angle of incidence may be changed within a certain tolerance. However, accurate measurements require knowledge of each angle of incidence with high accuracy. This problem can be solved by using a calibration stage. This can for example be implemented in the following way. A known object is measured, e.g., SiO_2 layer on Si with the known thicknesses (commercially available from VLSI Standards Inc), and the actual angle of incidence is calculated by reaching the best fit between measured value of the film thickness in calibration standard parameters and its specified value.

It is typically desirable to set a measurement spot on the same place (x, y, z) on the wafer for all the angles of incidence, which is practically difficult to implement with the currently available alignment technique. To solve this problem, the coordinates (x, y, z) of the measurement spot may be determined for each incident angle separately by carrying out another calibration procedure. A calibration target in the form of a small mirror, e.g., chrome-on-glass mirror of a $50\mu\text{m}$ diameter may be used. By changing x, y and z coordinates of the wafer supporting stage, a maximal signal of the returned light (reflection) is determined for each incident angle. This correction of coordinates (Δx , Δy and Δz) is stored in the memory of the measurement system (a control unit). Thus, while changing the angle of incidence/collection by selecting a corresponding pair of the deflector elements, the position of the wafer stage is changed accordingly to compensate for Δx , Δy and Δz for this specific angle.

Reference is now made to Figs. 3A-3D showing several examples of the configuration of the separate deflector elements suitable to be used in the system 100. In the example of Fig. 3A, the deflector element 208 has a planar reflecting surface (mirror), which may be associated with a lens 209 for beam focusing purposes, as shown in Fig. 3B. In the example of Fig. 3C, a deflector element 308 has a curved (concave) reflecting surface (preferably, a parabolic mirror) thereby

providing both the deflection and focusing of the incident beam. As shown in Fig. 3D, a deflector assembly part 408 (associated with either illumination or detection channel) can be formed with discrete deflector elements 408A-408D supported in a step-like structure, so as to be moved together by a common drive (not shown). It should be noted that the deflector elements used in arrays of the illumination and detection channels are not necessarily of the same type, but may be of different types. For example, the illumination channel may include the curved mirrors, while the detection channel may include planar mirrors.

Fig. 4 illustrates an optical system 500 according to another embodiment of the invention. To facilitate understanding, the same reference numbers are used for identifying components that are common in systems 100 and 500. In the system 500, the plurality of deflector elements in a light directing assembly 506 includes two symmetrical sectors 508 and 510 of a parabolic mirror accommodated in, respectively, illumination and detection channels and oriented such that the measurement site (location L) is located in the focal point of the mirror. Further provided in the light directing assembly 506 is a pair of movable planar mirrors 512 and 514 located in, respectively, illumination and detection channels IC and DC. In the present example, in distinction to the previously described ones, each of the continuous parabolic reflecting surfaces of the mirror sectors 508 and 510 presents an array of deflector elements (deflecting locations), providing a plurality of different angles of incidence/collection. In order to select a desired one of the incident angles, the mirror 512 is moved along the X-axis into a corresponding position with respect to the mirror sector 508. Similarly, in order to collect light returned from the sample with a desired angle (e.g., specular reflection), the mirror 514 is brought to a corresponding position along the X-axis. It should be understood that the provision of a continuous parabolic surface allows for obtaining the light response intensity (e.g., specular reflection) as a continuous function of angle of incidence.

In the systems 100 (Fig. 2) and 500 (Fig. 4), multiple, non-zero angles of incidence of the beam onto the sample are utilized. Fig. 5 schematically illustrates how such a system can be easily modified in order to provide also measurement/monitoring of the sample with the normal incidence (zero-angle). A system 600 is shown having a light source 602, a detector unit 604, and a light directing assembly 606 comprising the plurality of deflector elements (including two arrays of deflector elements 608 and 610 in the present example), mirrors 612, 614 and 616, and a beam splitter 618. The detector unit 604 has a spectroscopic detector 605 and a tube lens 622. Optionally provided in the system 600 are polarizing elements 620 and 621 located, respectively, in the optical path of a light beam emitted by the light source 602 and a light beam propagating to the detector unit. Mirrors 612 and 616 are mounted for movement (e.g., rotation) between their operative and inoperative states.

When the mirrors 612 and 616 are in the operative state, i.e., in the path of the incident and reflected beams B and B', respectively, the multi-angle mode is realized. The beam B is reflected by the mirror 612 to propagate through the multi-angle illumination IC, thereby resulting in the beam incidence onto the sample with a certain non-zero angle of incidence, and the returned beam B' propagates through the multi-angle detection channel DC to be reflected by the mirror 616 to the detector unit 604. By shifting the mirrors 612 and 616 into their inoperative state, i.e., being out of the optical path of the beams B and B', the beam B is directed towards the beam splitter 618 to propagate through a normal illumination/detection channel IC'. The beam splitter 618 reflects the beam B to propagate to the sample along the axis OA through an objective lens OL. A specular reflection B'_{nor} of the normal incident beam B_{nor} propagates along the axis OA through the beam splitter 618, and is reflected by the mirror 614 to the detector unit 604.

It should be understood that the normal incidence illumination/detection channel can utilize separate illuminator and detector, other than those used in the multi-angle illumination/detection system. This is schematically shown in Figs. 6A and 6B. In the example of Fig. 6A, an optical system 700A has a multi-angle illumination/detection sub-system constructed similarly to the system 100 of Fig. 2, and a normal illumination/detection sub-system 701. The sub-system 701 has a light source 703, a detector 704, and a suitable optics including a beam splitter BS, an objective lens OL, and a tube lens TL, and is accommodated such that, in each relative location of the sample relative to the optical system 700A, the same site L is measured/monitored by both sub-systems 100 and 701A. An optical system 700B of Fig. 6B, similar to the system 700A, utilizes the sub-systems 100 and 701, but with the sub-system 701 being applied to a measurement site L_1 spaced-apart from the site L to which the sub-system 100 is applied. In this case, a relative distance between the sites L and L_1 is determined in a simple calibration procedure and stored in the system memory.

It should be understood that the normal incidence/detection sub-system 701 can be used as an imaging module, being a microscope with a CCD detector and suitable illumination and imaging optics. A control unit (not shown) of the system thus has an electronic card (frame grabber) for grabbing a video signal from the CCD, and an image processing software (including pattern recognition) for processing the grabbed signal. The pattern recognition software allows for identifying the measurement site and, in combined operation with X, Y, Z movable system (stage), allows for localizing the required measurement site in the measurement position (site L) as a point of intersection between the axes of the illumination and detection channels.

Reference is made to Figs. 7A and 7B illustrating optical systems 800A and 800B, respectively, each designed for carrying out multi-angle and normal incidence measurement/monitoring, as well as imaging and auto-focusing

functions. To facilitate understanding, the same reference numbers are used for identifying the similar components in the systems 800A and 800B. The systems differ from each other in that the pluralities of deflector elements of the systems 800A and 800B comprise, respectively, arrays of separate, spaced-apart deflector elements (808A and 810A) and two continuous deflecting surfaces defining the arrays of deflector elements (808B and 810B).

Thus, the system 800A (and 800B) comprises a multi-angle and normal-incidence measurement sub-system 801 utilizing a light source 802 (e.g., a Xe lamp with appropriate optics) and a detector unit 804 (e.g. spectrophotometer based on grating and photo-diode array); and an imaging and auto-focusing sub-system 805 utilizing a light source 806 (QTH lamp with appropriate optics) and a detector unit 807 (including a CCD camera). The sub-system 801 further comprises a light directing assembly 809 including the plurality of deflector elements, mirrors 812A (or 812B in system 800B), 814 and 816A (or 816B in system 800B), a beam splitter 818, and objective and tube lenses 819 and 820. Preferably, the light directing assembly of the sub-system 801 also comprises polarizing elements 821 and 822. The detector unit 804 preferably also comprises an aperture stop 823 and a pinhole aperture 824. The aperture stop 823 is used for adjusting numerical aperture of the reflected light beam. The pinhole aperture 824 is used to limit a measured area on the wafer W.

In both systems 800A and 800B, each of the mirrors 812A (or 812B) and 816A (or 816B) is shiftable between its inoperative state (out of the optical path of the respective beam) and operative state (in the path of the respective beam) as described above with reference to Fig. 5. In the system 800A, at least some of the deflector elements in the arrays 808A and 810A are movable to provide operative and inoperative state of the selected deflector element in each array, while in the system 800B, the parabolic mirrors 808B and 810B are stationary mounted, and mirrors 812B and 816B are additionally movable along the X-axis between

different operative positions thereof to thereby provide the operative state of the selected deflector element in the arrays (deflecting location).

When the mirrors 812A and 816A are in the operative state, a beam B from the light source 802 is directed to the sample through the multi-angle illumination channel IC (with only one deflector element in the array 808A being currently operative), and a reflection B' of the inclined incident beam B propagates through the multi-angle detection channel DC to the mirror 816B, which reflects the beam B' to the detector unit 804. When the mirrors 812A and 816B are inoperative, the beam B is reflected from the beam splitter 818 to normally impinge onto the same location L on the sample, and a reflection B'_{nor} passes through the beam splitter 818, and is reflected by the mirror 814 to the detector 804.

The sub-assembly of the light directing assembly including the beam splitter 818 and mirror 814 is also movable (e.g., along the X- or Y- axis) between its operative and inoperative position to be, respectively, in and output of the optical path of the respective beams. When this sub-assembly is operative, the system 800A functions as described above, namely, carries out measurements with the sub-system 801. In order to operate the sub-system 805 to carry out pattern recognition and/or auto-focusing, the sub-assembly 818-814 is shifted into its inoperative state.

The sub-system 805 comprises a grid assembly 825, a beam splitter 826 for spatially separating incident and reflected beams B_{inc} and B_{ref}, and a tube lens 827. There are several ways to reach the best focus. As shown in the figure, beam B_{inc} passes through the grid assembly 825, is reflected by the beam splitter 826, and is focused onto the sample by the tube lens 827 and the objective lens 819. The reflected beam B_{ref} propagates back to the CCD 804 through the beam splitter 826. The use of the grid assembly 825 is aimed at finding the best focus by analyzing the image of line arrays (grid) projected on the sample plane

through the illumination channel. This technique is disclosed in U.S. Patent No. 5,604,344 assigned to the assignee of the present application. Generally, another auto-focusing sensors may be applied as well.

Turning now to Fig. 8, there is illustrated yet another embodiment of an optical system 900 according to the invention. The system 900 comprises a light source 902 optionally associated with a polarizing element 903; a detector unit 904 (e.g., including a spectrophotometer) also optionally associated with a polarizing element 905; and a light directing assembly 906. The light directing assembly 906 comprises a double-side movable planar mirror 908, a wavelength-selective beam combiner 910 (e.g., transparent for wavelength more than 750nm and reflective for wavelengths up to 750nm), three planar mirrors 912, 914 and 916, and a parabolic-sector mirror 918 whose continuous reflecting surface facing the sample's plane presents a plurality of deflector elements. The mirror 918 is formed with an opening 918A (generally, an optical window), where for example an objective lens 919 can be located. The provision of the optical window enables a normal incidence illumination/detection. The wavelength selectivity of the mirror 910 is optional and is associated with the provision of an imaging channel formed by an additional light source 920, an imaging detector unit 922 (e.g., CCD camera), a beam splitter 924 and a tube lens 925. It should be noted that the use of the additional light source 920 is optional, and the same light source 902 can be used in the imaging channel, in which case the mirror 908 is shifted into its extreme left position denoted 908'. Further provided in the light directing assembly is a beam splitter 926 serving for the normal incidence measurement, as well as for imaging purposes in this specific configuration. A grid assembly 927 is appropriately accommodated in front of the light source 920 for auto-focusing purposes.

It should be noted that the double-side movable planar mirror 908 can be replaced by two single-side planar movable mirrors. The dimensions of the

mirror 908 (thickness and length) are defined by the predetermined plurality of incident angles, as well as by the configuration of the optical scheme, including dimensions of the beam splitter 926, etc.

The system 900 operates in the following manner. In the multi-angle illumination/detection mode, mirrors 908, 910, 912, 914 serve for sequential reflection of a light beam B emitted by the light source 902 towards the mirror 918. The position of the mirror 908 along the X-axis defines the deflector element (deflecting location) on the continuous reflecting surface of the mirror 918 on which the light beam B would impinge, and therefore defines the angle of incidence of the beam B onto the location L on the sample S. In the normal-incidence mode, the mirror 908 is in its extreme position 908', and the beam B is sequentially reflected by mirrors 908' and 910, and is then reflected by the beam splitter 926 to propagate through the opening 918A to the location L on the sample. The normally reflected beam would propagate back through the beam splitter 926 towards the detector unit 904. In the imaging mode, beam B" produced by the light source 920 is reflected from the beam splitter 924 and transmitted by the wavelength-selective mirror 910 to be further reflected from the beam splitter 926 towards the location L along the axis perpendicular to the sample's plane. A normally reflected imaging beam propagates back and is reflected by the beam splitter 926 to the CCD 922.

As indicated above, an imaging channel may be combined with a normal incidence illumination/detection channel. This allows for combining spectral measurements at both normal and oblique illumination in the single measurement system. In the case of spectrometry, this also allows, in some cases, for measuring diffraction efficiency for the first (negative) diffraction order additionally to zero order standard measurements. A schematic beam propagation scheme is schematically illustrated in Fig. 9. The patterned sample S has a grid G (line array). An illuminating beam B impinges onto the grid

with a certain non-zero angle of incidence, and the first negative diffraction order B_1 , angle $(-\varphi)$, and a zero-order beam B_2 (specular reflection) can be detected. A relative angular position (φ) can be detected for each wavelength of incident light, as follows: $2d\sin(\varphi)=m\lambda$, wherein d is the period of grid, λ is the wavelength and m is integer corresponding to the diffraction order number.

It is thus evident that the present invention provides a simple construction of an optical system having a deflector assembly with at least one movable element capable of providing variable angles of incidence and light collection with stationary mounted light source and detector. The system can be easily adjusted for additionally illuminating the same location (site) of the sample with a normal incident beam, as well as for imaging the same site.

Data indicative of the detected light is received at a control unit having a suitable data processing utility, which is operable to analyze the received data and determine at least one of the following sample's parameters: reflectivity R as a function of wavelengths or angle of incidence or both; diffraction efficiency as a function of wavelength at zero order diffraction; and typical ellipsometry measurable parameters such as Δ , which is a change in phase of the reflected beam from the incident beam, and ψ , which is defined as the arctangent of the amplitude ratio of the incident and reflected beams.

Those skilled in the art will readily appreciate that various modifications and changes can be applied to the embodiments of the invention is hereinbefore exemplified without departing from its scope defined in and by the appended claims

CLAIMS:

1. An optical system for use in measurements in a sample, the system comprising:

- (a) a light source operable to produce an incident light beam propagating in a certain direction towards the sample through an illumination channel;
- (b) a detector unit for collecting light coming from the sample through a detection channel, and generating data indicative of the collected light;
- (c) a light directing assembly operable to direct the incident beam onto a certain location on the sample's plane with a plurality of incident angles, and to direct light returned from the illuminated location to the detector unit, the light directing assembly comprising a plurality of beam deflector elements, at least one of the deflector elements being movable, a position of said at least one movable deflector element defining a selected one of the incident angles.

2. The system according to Claim 1, wherein the plurality of said deflector elements comprises two arrays of the deflector elements, one array being located in the illumination channel and the other array being located in the detection channel.

3. The system according to Claim 2, wherein each of the two arrays is formed by deflector elements arranged in a spaced-apart relationship along the respective channel.

4. The system according to Claim 3, wherein the deflector elements are mirrors having planar or parabolic-sector reflecting surface.

5. The system according to Claim 4, wherein each of the deflector elements has its associated focusing lens.
6. The system according to Claim 2, wherein each of the two arrays is formed by a reflecting surface of a parabolic-sector mirror.
7. The system according to Claim 6, wherein the light directing assembly comprises a planar mirrors located in the optical part of the incident beam propagating towards the array of the deflector elements in the illumination channel and movable along this optical path to thereby reflect the incident beam onto the selected one of the deflector elements of the illumination channel.
8. The system according to Claim 7, wherein the light directing assembly comprises a second planar mirror accommodated in the detection channel in the optical part of the returned deflected beam and movable along this channel, movement of the second mirror resulting in the detection of the returned beam deflected by the selected one of the deflector elements of the detection channel.
9. The system according to Claim 1, wherein the plurality of the deflector elements comprises a parabolic-sector mirror facing the sample by its reflecting surface, and comprises several planar mirrors operable together to direct the incident beam to the reflecting surface of the parabolic-sector mirror to be reflected thereby onto said location on the sample, and to direct the returned beam to the detector unit, at least one of the planar mirrors being movable between a plurality of operative positions, thereby directing the incident beam onto a selected location on the reflecting surface and enabling obtaining a selected one of the plurality of incident angles.
10. The system according to any one of preceding Claims, wherein the detector unit comprises a spectroscopic detector.
11. The system according to Claim 10, wherein the detector unit comprises a pinhole accommodated upstream of the spectroscopic detector with respect to the direction of propagation of the returned beam towards the detector unit.

12. The system according to Claim 11, wherein the detector unit comprises an aperture stop accommodated upstream of the pinhole with respect to the direction of propagation of the returned beam towards the detector unit.

13. The system according to any one of preceding Claims, wherein the light directing assembly comprises a polarizing assembly.

14. The system according to Claim 13, wherein the polarizing assembly comprises at least one polarizer located in the optical path of either the incident light beam produced by the light source, or the returned deflected beam propagating to the detector unit.

15. The system according to any one of preceding Claims, wherein the light directing assembly defines an additional illumination/detection channel for directing the incident beam onto the sample along an axis perpendicular to the sample's plane and directing a reflection of the perpendicular incident beam to the detector.

16. The system according to Claims 6 and 9, wherein the light directing assembly defines an additional illumination/detection channel for directing the incident beam onto the sample along an axis perpendicular to the sample's plane and directing a reflection of the perpendicular incident beam to the detector, the additional illumination/detection channel being formed by a beam splitter spatially separating the perpendicular incident and reflected beams, and first and second planar mirrors, each being additionally shiftable between its operative and inoperative positions being, respectively, in and out of the optical path of the respective beam, such that when the first and second planar mirrors are in their operative positions, the incident and returned beams propagate through the illumination and the detection channels, respectively, and when the first and second planar mirrors are in their inoperative states, the incident and returned beams propagate through the additional illumination/detection channel.

17. The system according to Claims 2 and 9, wherein the light directing assembly defines an additional illumination/detection channel for directing the incident beam onto the sample along an axis perpendicular to the sample's plane and directing a reflection of the perpendicular incident beam to the detector, the additional illumination/detection channel being formed by a beam splitter spatially separating the perpendicular incident and reflected beams, and first and second planar mirrors, the first mirror being located in the optical part of the incident beam and being shiftable between its operative and inoperative positions being, respectively, in and out of the optical path of the incident beam, and the second planar mirror being accommodated in the optical part of the returned beam and being shiftable between its operative and inoperative positions being, respectively, in and out of the optical path of the returned beam, such that when the first and second planar mirrors are in their operative positions, the incident and returned beams propagate through the illumination and the detection channels, respectively, and when the first and second planar mirrors are in their inoperative states, the incident and returned beams propagate through the additional illumination/detection channel.

18. The system according to any one of the preceding Claims, comprising an imaging channel defined by an imaging light source, an imaging detector unit and an imaging lens assembly.

19. The system according to Claim 18, wherein said imaging channel comprises an auto-focusing arrangement.

20. An optical method for use in measuring in a sample, the method comprising:

- (i) providing an incident light beam propagating in a certain direction towards the sample along an illumination channel;
- (ii) directing the incident beam onto a certain location on the sample's plane with a plurality of incident angles, said directing comprising deflecting the incident beam by a selected one of a plurality of deflector elements

resulting in the selected one of the angles of incidence of the beam onto said certain location; and

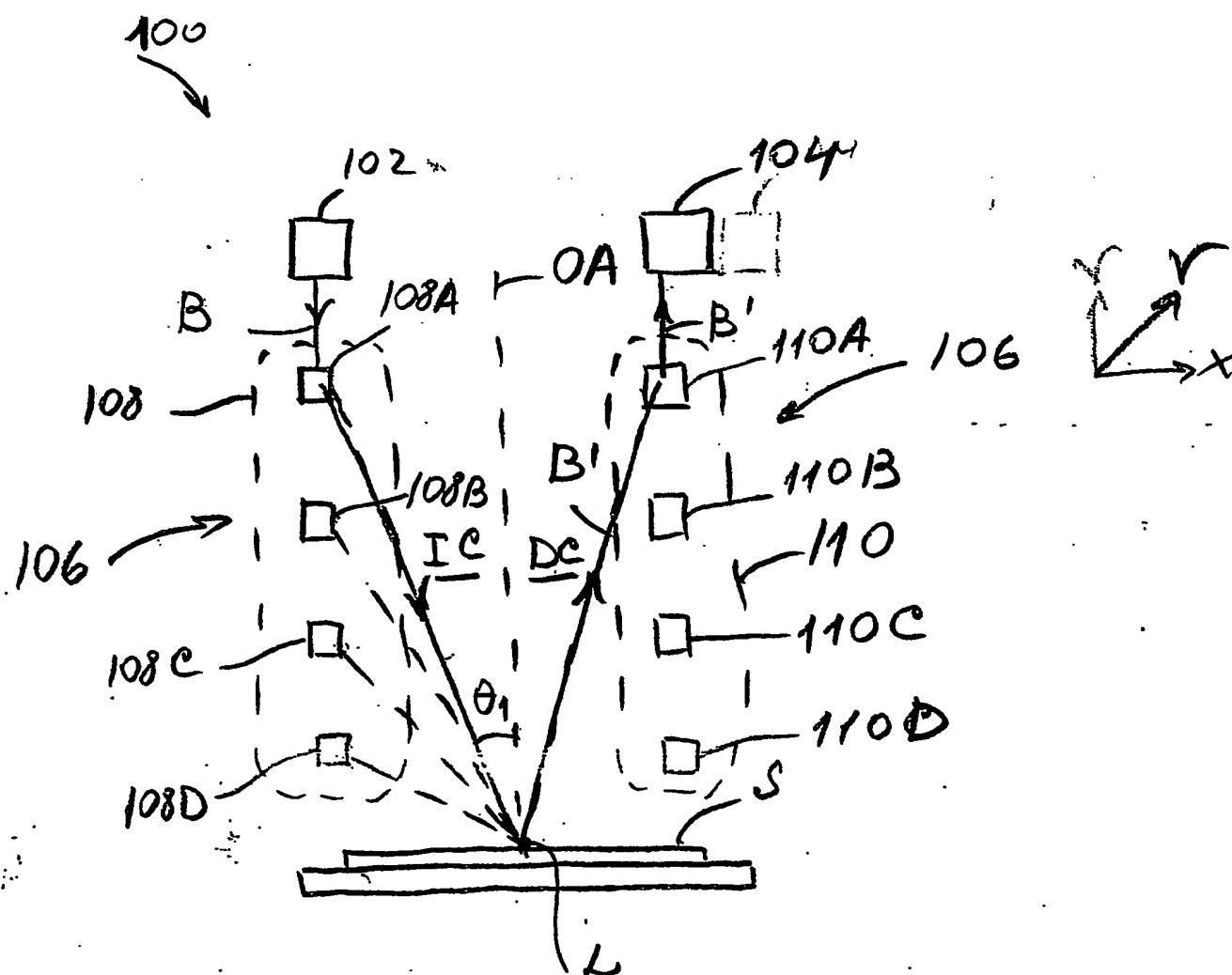
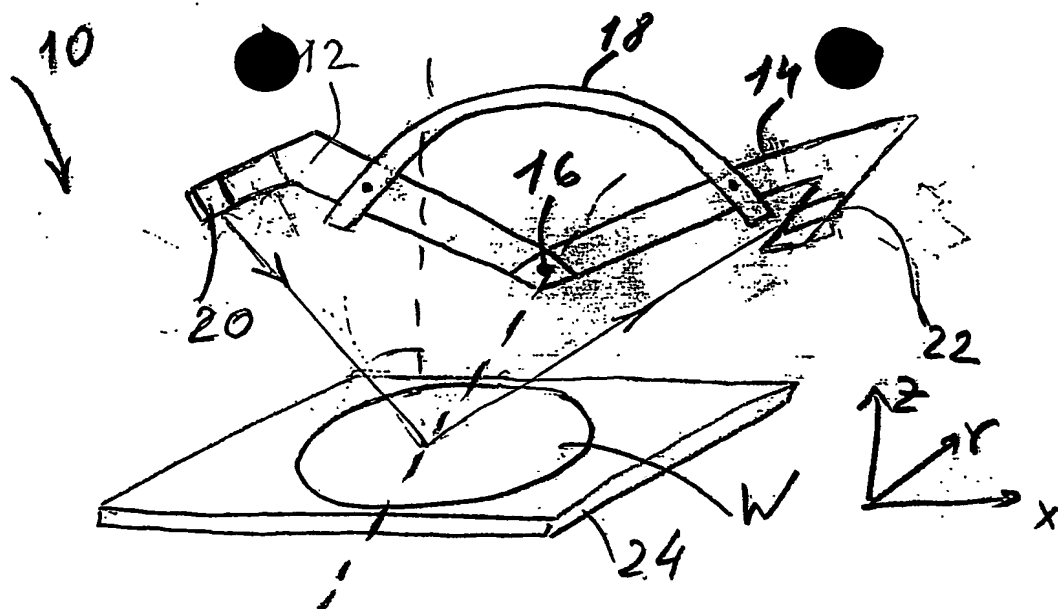
- (iii) detecting light returned from the illuminated location with a desired angle and generating data indicative thereof to be analyzed for determining at least one parameter of the sample.

21. The method according to Claim 20, wherein said at least one parameter includes at least one of the following: $R(\lambda)$, wherein R is the reflectivity of the sample and λ is the wavelength of incident light; $R(\theta)$, wherein θ is the angle of incidence; $R(\lambda, \theta)$; diffraction efficiency as a function of wavelength at zero order diffraction; a change Δ in phase of the returned beam from the incident beam; the amplitude ratio ψ of the incident and returned beams; $\Delta(\lambda)$ and $\psi(\lambda)$ for specularly reflected or zero order diffracted returned light.

For the Applicants
REINHOLD COHN AND PARTNERS

By s





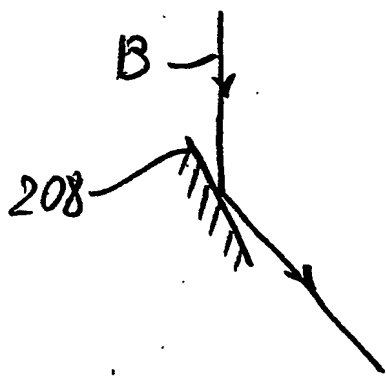


Fig. 3 A

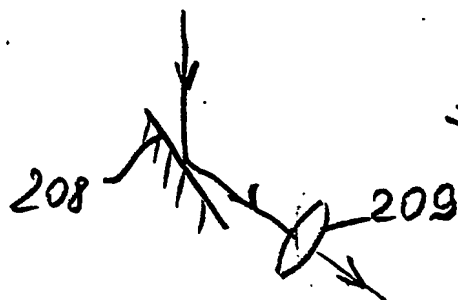


Fig. 3 B

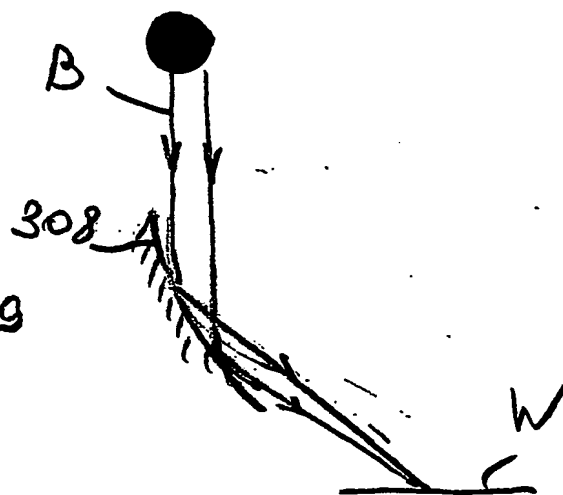


Fig. 3 C

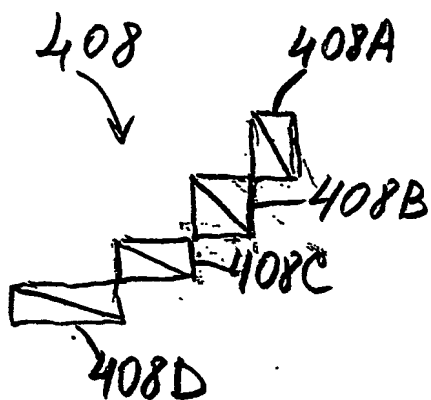


Fig. 3 D

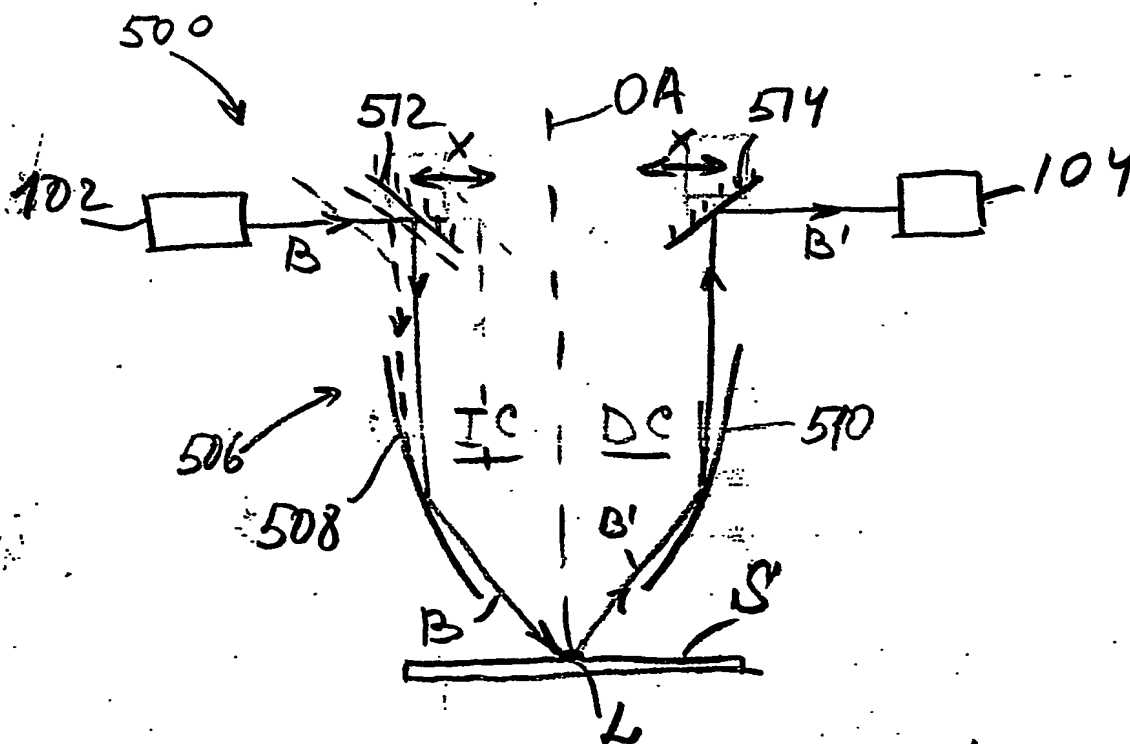


Fig. 4.

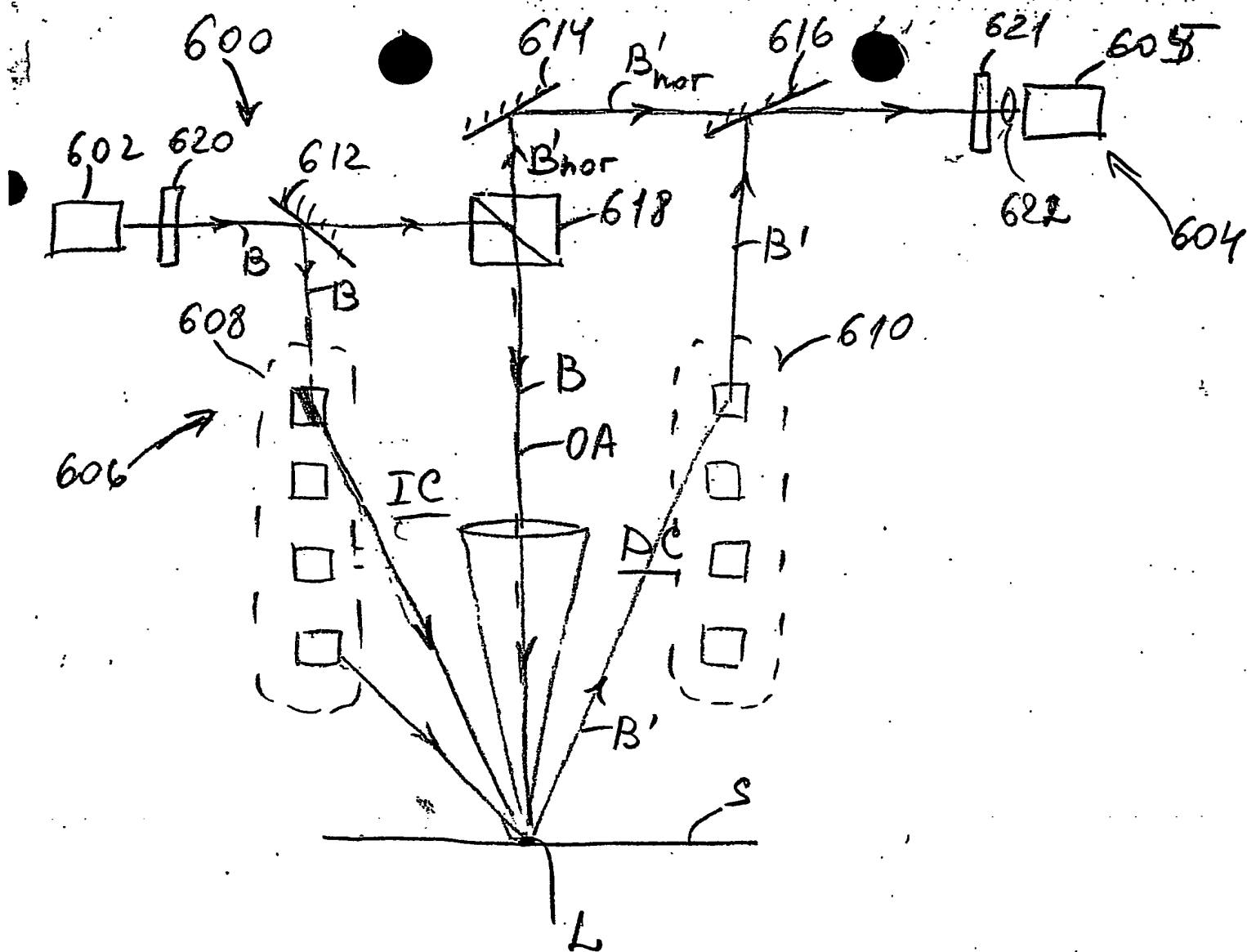


Fig. 5

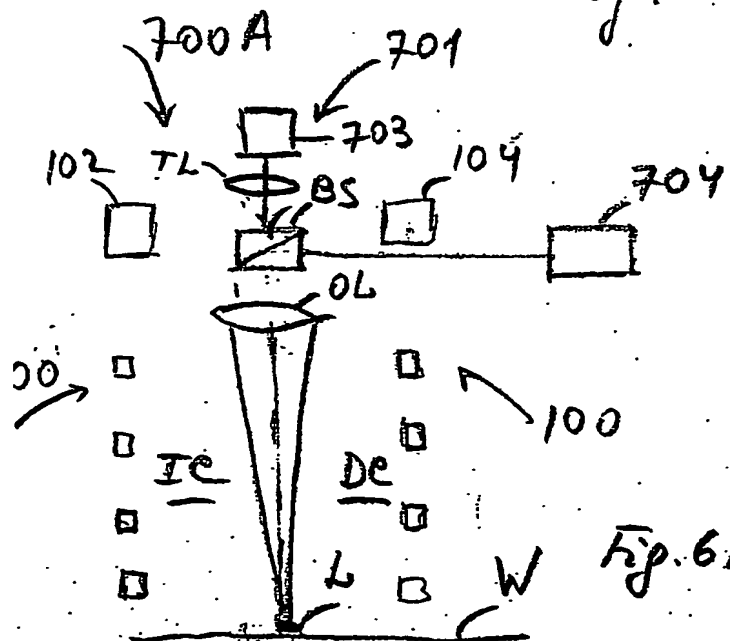
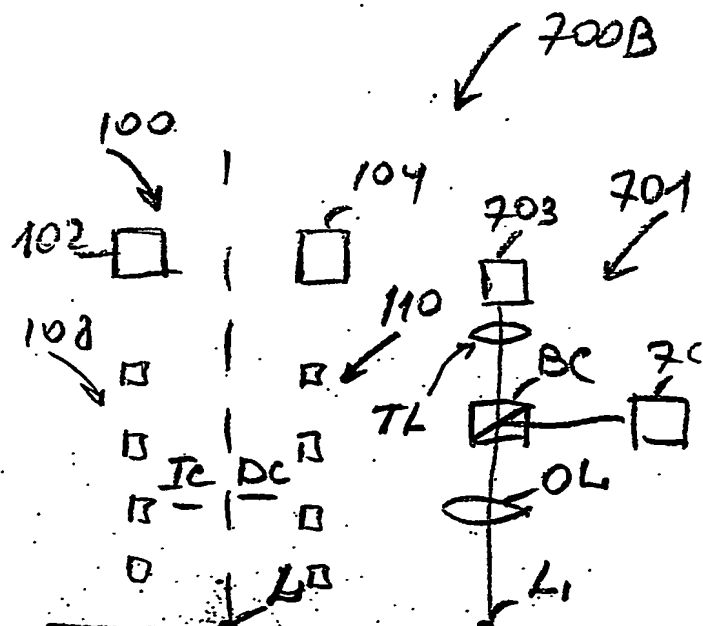


Fig. 6A



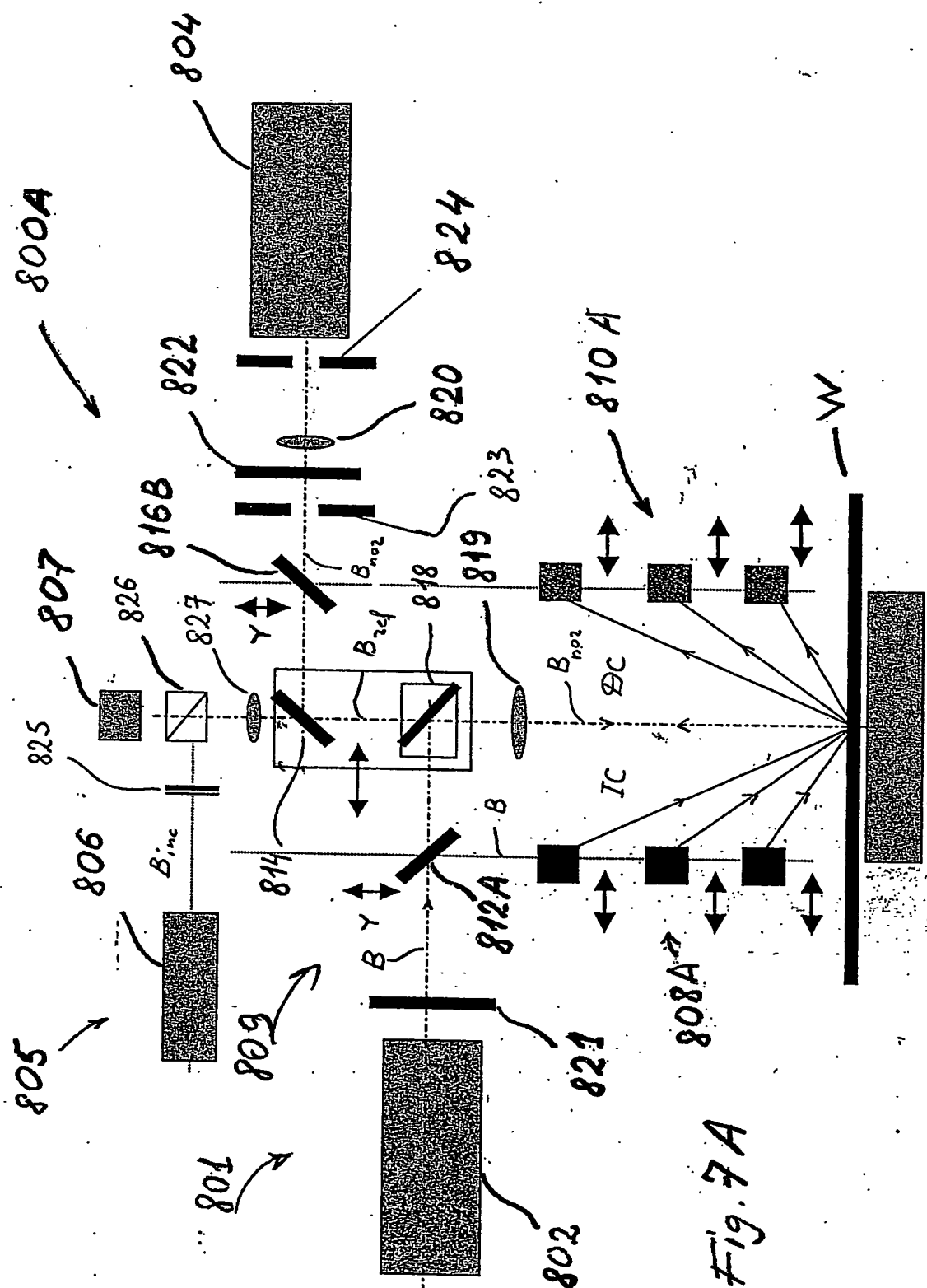


Fig. 7A

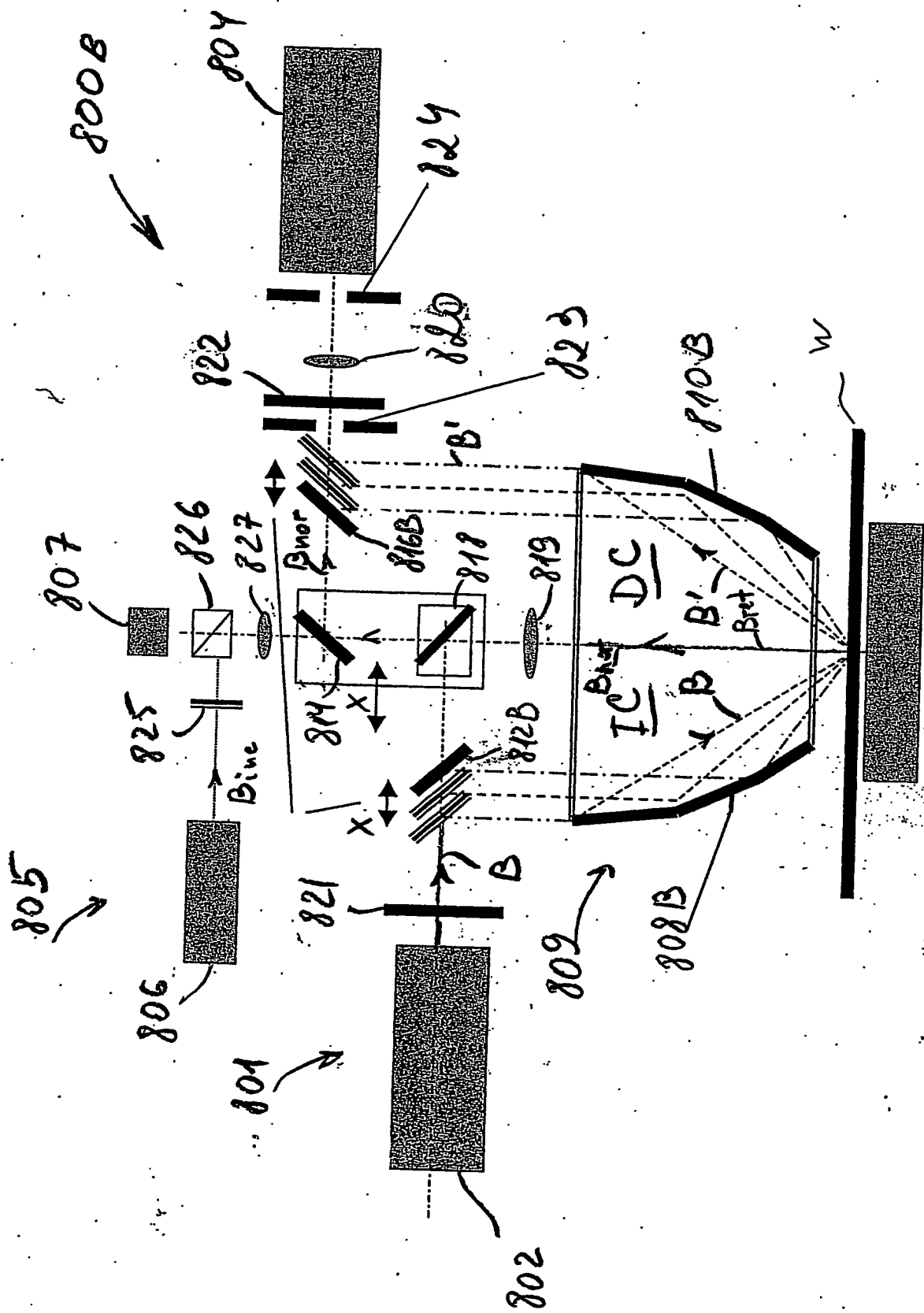


Fig. 7B

**This Page is Inserted by IFW Indexing and Scanning
Operations and is not part of the Official Record**

BEST AVAILABLE IMAGES

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images include but are not limited to the items checked:

- ☐ BLACK BORDERS
- ☐ IMAGE CUT OFF AT TOP, BOTTOM OR SIDES
- ☐ FADED TEXT OR DRAWING
- ☒ BLURRED OR ILLEGIBLE TEXT OR DRAWING
- ☐ SKEWED/SLANTED IMAGES
- ☐ COLOR OR BLACK AND WHITE PHOTOGRAPHS
- ☐ GRAY SCALE DOCUMENTS
- ☐ LINES OR MARKS ON ORIGINAL DOCUMENT
- ☐ REFERENCE(S) OR EXHIBIT(S) SUBMITTED ARE POOR QUALITY
- ☐ OTHER: _____

IMAGES ARE BEST AVAILABLE COPY.

As rescanning these documents will not correct the image problems checked, please do not report these problems to the IFW Image Problem Mailbox.